

DME 500

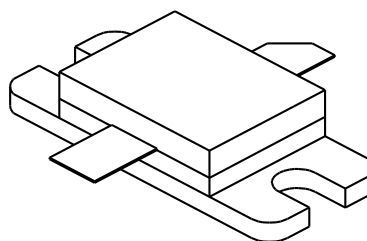
500 Watts, 50 Volts, Pulsed
Avionics 1025 - 1150 MHz

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GENERAL DESCRIPTION

The DME 500 is a high power COMMON BASE bipolar transistor. It is designed for pulsed systems in the frequency band 1025-1150 MHz. The device has gold thin-film metallization for proven highest MTTF. The transistor includes input and output prematch for broadband capability. Low thermal resistance package reduces junction temperature, extends life.

CASE OUTLINE 55KT, STYLE 1



ABSOLUTE MAXIMUM RATINGS

Maximum Power Dissipation @ 25°C² 1700 Watts

Maximum Voltage and Current

BVces Collector to Base Voltage 55 Volts

BVebo Emitter to Base Voltage 3.5 Volts

Ic Collector Current 40 Amps

Maximum Temperatures

Storage Temperature - 65 to + 200°C

Operating Junction Temperature + 200°C

ELECTRICAL CHARACTERISTICS @ 25 °C

SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN	TYP	MAX	UNITS
P _{out}	Power Out	F = 1025-1150 MHz	500			Watts
P _{in}	Power Input	V _{cc} = 50 Volts			125	Watts
P _g	Power Gain	PW = 10 μsec	6.0	6.5		dB
η _c	Collector Efficiency	DF = 1%		35		%
V _{SWR}	Load Mismatch Tolerance	F = 1090 MHz			10:1	

BVebo	Emitter to Base Breakdown	I _e = 30 mA	3.5			Volts
BVces	Collector to Emitter Breakdown	I _c = 40 mA	55			Volts
h _{FE}	DC - Current Gain	I _c = 500 mA, V _{ce} = 5 V	10		100	
θ _{jc} ²	Thermal Resistance				0.1	°C/W

Note 1: At rated output power and pulse conditions

2: At rated pulse conditions

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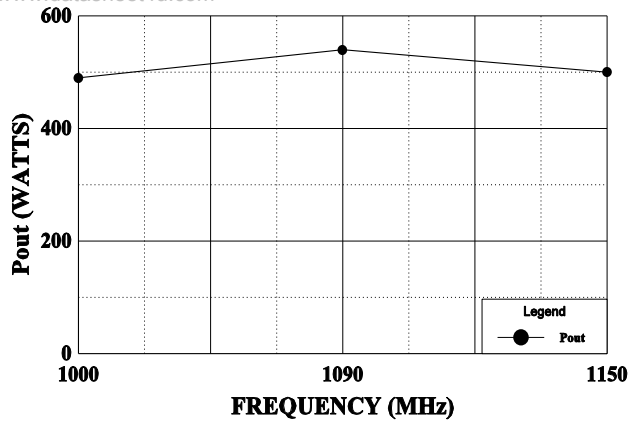
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RF·MICROWAVE SILICON POWER TRANSISTORS

POWER OUTPUT

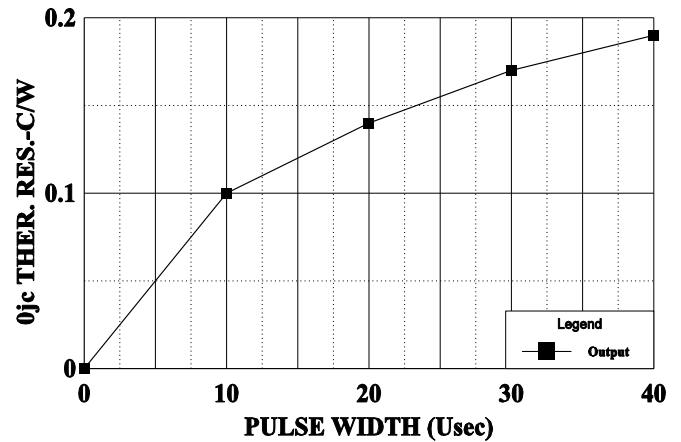
Vcc = 50 V, Pin = 125 W Peak



DME 500

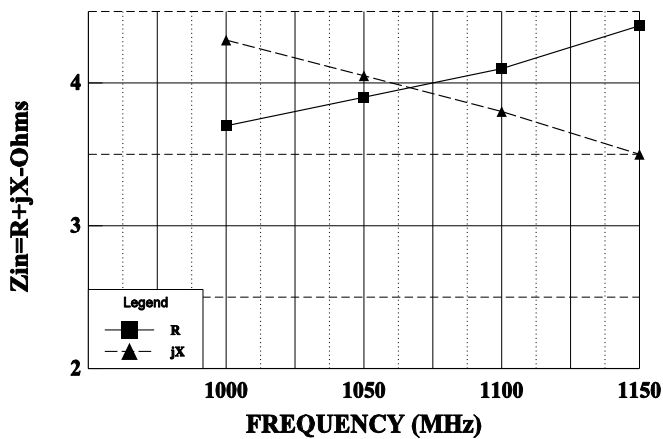
THERMAL RESISTANCE vs PULSE WIDTH

Vcc = 50 V, Tf = 30 C



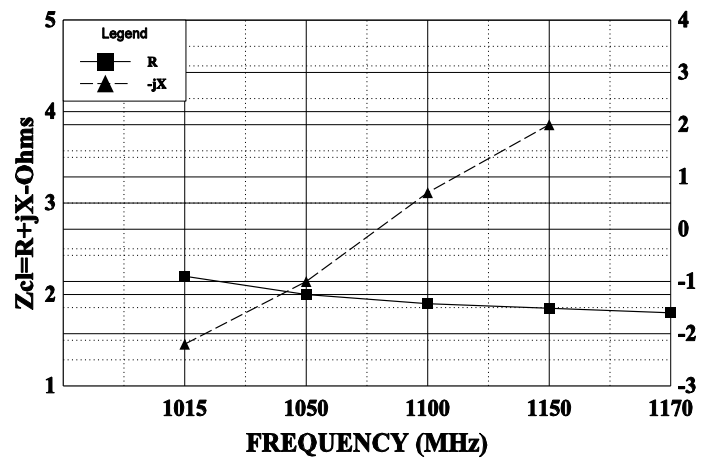
SERIES INPUT IMPEDANCE vs FREQUENCY

Vcc = 50 V, Po = 250 W



SERIES LOAD IMPEDANCE vs FREQUENCY

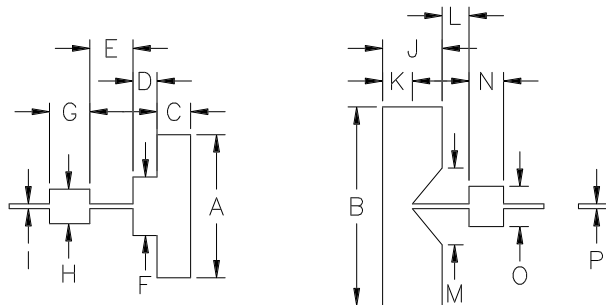
Vcc = 50 V, Po = 500 W



REVISIONS

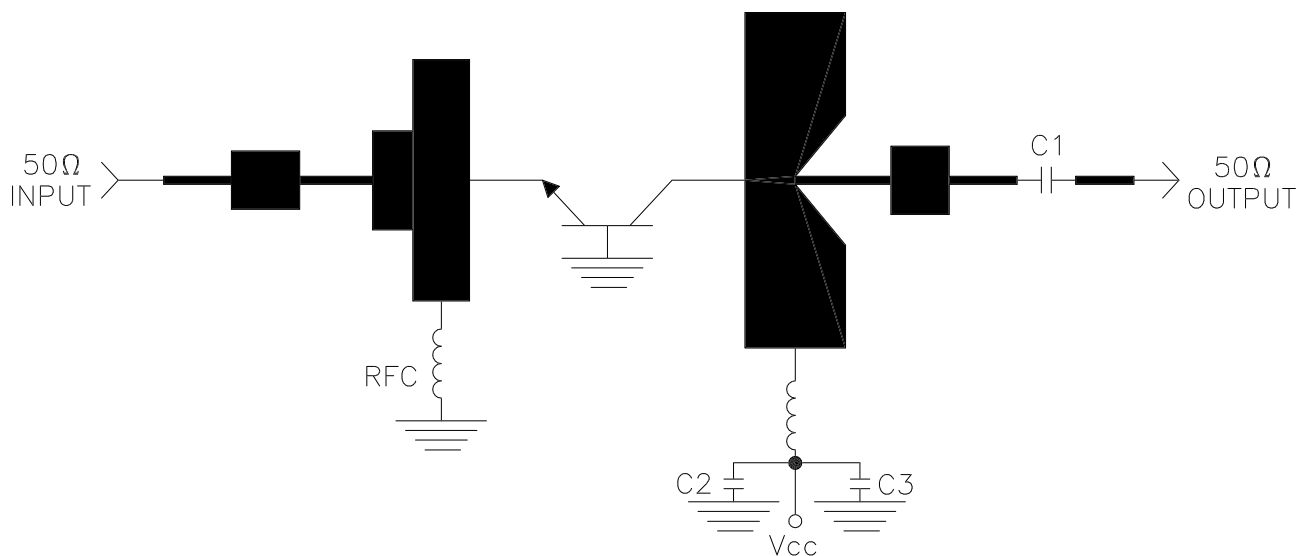
ZONE	REV	DESCRIPTION	DATE	APPROVED
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DIM	INCHES
A	.745
B	1.035
C	.175
D	.125
E	.225
F	.305
G	.210
H	.180
I	.025
J	.310
K	.155
L	.140
M	.400
N	.180
O	.210
P	.025

1025/1150 MHz TEST AMPLIFIER



— = Microstrip line on E10, t=0.025"
 C1, C2 = 82PF chip capacitor
 C3 = 500 μ F Dc @ 75V capacitor



CH₂ TECHNOLOGY

CAGE
0PJR2

DWG NO

DME 500

REV **A**

SCALE

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